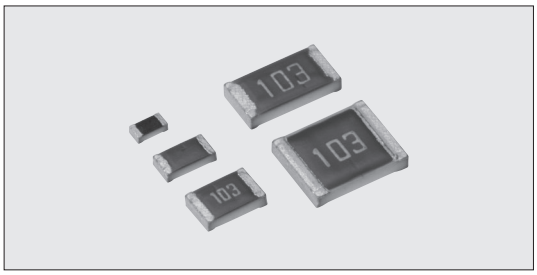
EU RoHS

SG73S Endured Surge Voltage Flat Chip Resistors



Coating color：Black（1E）
Green（1J, 2A, 2B, 2E）

■Features

- Superior to RK73 series chip resistors in surge withstanding voltage and high power.
- Resistance tolerance is available from ±0.5%.
- Suitable for both reflow and flow solderings.
- Products with lead free termination meet EU-RoHS requirements. EU-RoHS regulation is not intended for Pb-glass contained in electrode, resistor element and glass.
- AEC-Q200 Qualified.

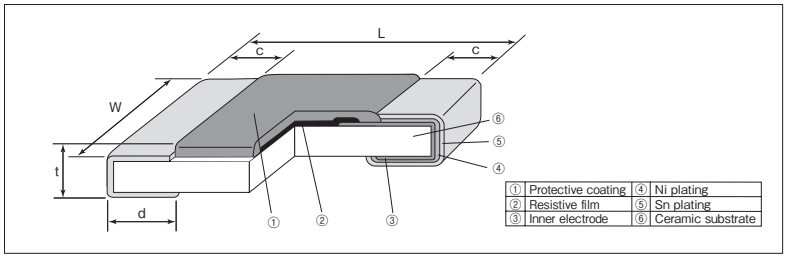
■Applications

- E.C.U.
- Circuits to catch inductive lighting surge.

■Reference Standards

IEC 60115-8
JIS C 5201-8
EIAJ RC-2134C

■Construction



■Dimensions

Type (Inch Size Code)	Dimensions (mm) L	W	c	d	t	Weight (g) (1000pcs)
1E (0402)	$1.0^{+0.1}_{-0.05}$	0.5±0.05	0.15±0.1	$0.25^{+0.05}_{-0.1}$	0.35±0.05	0.68
1J (0603)	1.6±0.2	0.8±0.1	0.3±0.1	0.3±0.1	0.45±0.1	2.14
1J AT (0603)			0.35±0.15	0.5±0.2		
2A (0805)	2.0±0.2	1.25±0.1	$0.3^{+0.2}_{-0.1}$	$0.3^{+0.2}_{-0.1}$	0.5±0.1	4.54
2A AT (0805)			0.45±0.25	0.6±0.2	0.55±0.1	
2B (1206)	3.2±0.2	1.6±0.2	$0.4^{+0.2}_{-0.1}$	$0.4^{+0.2}_{-0.1}$	0.6±0.1	9.14
2B AT (1206)			0.55±0.35	0.8±0.2		
2E (1210)		2.6±0.2	$0.4^{+0.2}_{-0.1}$	$0.4^{+0.2}_{-0.1}$		15.5

■Type Desiqnation

Example

SG73S	2A		T	TD	103	J
Product Code	Power Rating※1	Characteristic	Terminal Surface Material	Taping	Nominal Resistance	Resistance Tolerance
	1E : 0.33W 1J : 0.5W 2A : 0.75W 2B : 1W 2E : 1.5W	Nil : Standard A : Heat shock resistance※2	T : Sn	TP: 2mm pitch punch paper TD: 4mm pitch punch paper TE: 4mm pitch plastic embossed BK: Bulk	D,F : 4 digits G,J : 3 digits	D : ±0.5% F : ±1% G : ±2% J : ±5%

※2 1J, 2A, and 2B are available for Heat shock resistance.
No resistance marking.
Contact us when you have control request for environmental hazardous material other than the substance specified by EU-RoHS.
For further information on taping, please refer to APPENDIX C on the back pages.

■Ratings

Type	Power Rating※1	Rated Ambient Temp.	Rated Terminal Part Temp.	T.C.R. (×10⁻⁶/K)	Resistance Range (Ω) D: ±0.5% E24・E96	F: ±1% E24・E96	G: ±2% J: ±5% E24	Max. Working Voltage	Max. Overload Voltage	Packaging & Q'ty/Reel (pcs) TP	TD	TE
1E	0.33W	70℃	105℃	±200	10～1M	1～1M	1～10M	75V	100V	10,000	—	—
1J	0.5W			±100	510～576k	510～576k	510～560k	150V	200V	10,000※5	5,000	—
				±100※3	10～499 590k～1M	1～499 590k～1M	1～470 620k～10M					
2A	0.75W			±200	10～1M	1～1M	1～10M	400V	600V (800V)※4	10,000※5	5,000	4,000※5
2B	1.0W			±200	10～1M	1～1M	1～10M	200V	400V	—	5,000	4,000※5
2E	1.5W			±200	10～1M	1～1M	1～10M	200V	400V	—	5,000	4,000※5

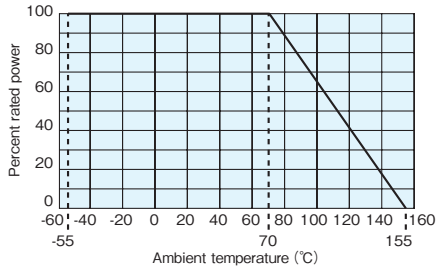
Operating Temperature Range：−55℃～+155℃
Rated voltage＝$\sqrt{\text{Power Rating}\times\text{Resistance value or Max. working voltage, whichever is lower.}}$
※1 If the terminal part temperature exceeds the rated terminal part temperature even if it is below the rated ambient temperature, apply the derating curve for the terminal part temperature.
※3 Cold T.C.R.（−55℃～+25℃） is ±150×10⁻⁶/K.
※4 Applies when power rating is 0.4W or lower.
※5 Standard packaging：TD(4mm pitch punch paper)
If any questions arise whether to use the "Rated Ambient Temperature" or the "Rated Terminal Part Temperature" in your usage conditions, please give priority to the "Rated Terminal Part Temperature".
For more details, please refer to "Introduction of the derating curves based on the terminal part temperature" on the beginning of our catalog.

Specifications given herein may be changed at any time without prior notice. Please confirm technical specifications before you order and/or use.
Contact our sales representatives before you use our products for applications including automotives, medical equipment and aerospace equipment.
Malfunction or failure of the products in such applications may cause loss of human life or serious damage.

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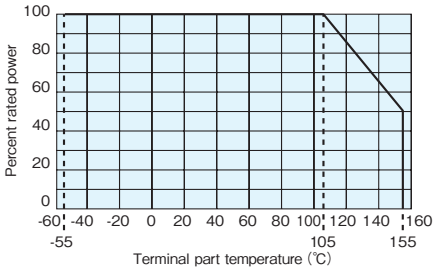
■Derating Curve

Ambient temperature



For resistors operated at an ambient temperature of 70℃ or higher, the power shall be derated in accordance with the above derating curve.

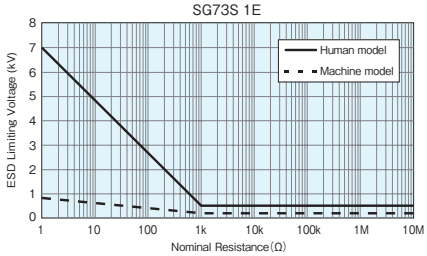
Terminal part temperature



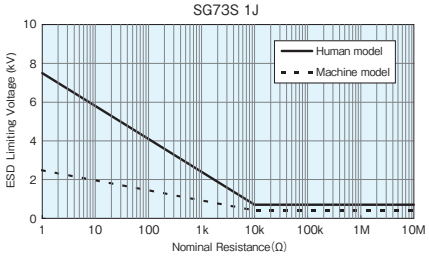
When the terminal part temperature of the resistor exceeds the rated terminal part temperature shown above, the power shall be derated according to the derating curve.
※Please refer to "Introduction of the derating curves based on the terminal part temperature" on the beginning of our catalog before use.

■ESD Limiting Voltage

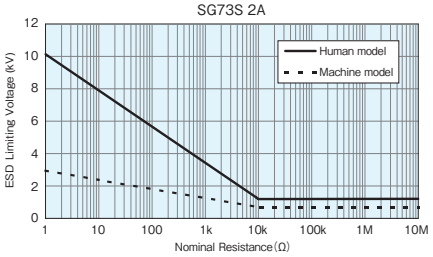
SG73S 1E



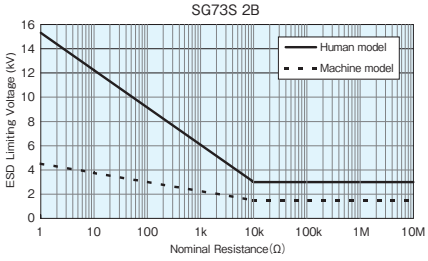
SG73S 1J



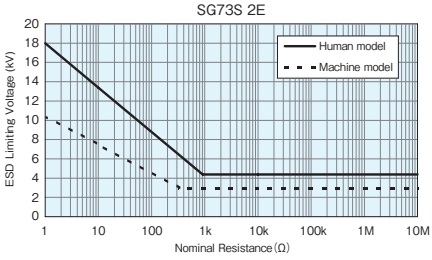
SG73S 2A



SG73S 2B

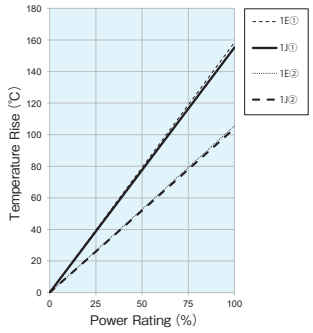


SG73S 2E

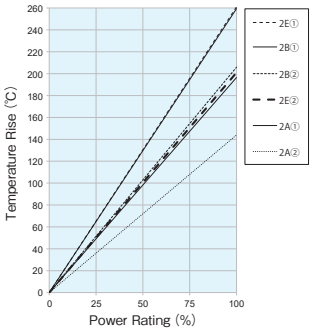


■Temperature Rise

SG73S 1E-1J

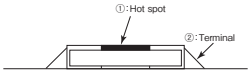


SG73S 2A-2E



Regarding the temperature rise, the value of the temperature varies per conditions and board for use since the temperature is measured under our measuring conditions.

Measurement condition
Room temperature: 25℃
PCB: FR-4 t = 1.6mm
Cu foil thickness: 35μm



■Performance

Test Items	Performance Requirements ΔR±(%+0.1Ω)		Test Methods
	Limit	Typical	
Resistance	Within specified tolerance	—	25℃
T.C.R.	Within specified T.C.R.	—	+25℃/−55℃ and +25℃/+125℃
Overload (Short time)	2	0.5	Overload for 5s Type: 1E / 1J / 2A / 2B / 2E Overload: 1.25W / 2.063W / 2W (1.6W※4) / 3W / 4W
Resistance to soldering heat	1	0.75	260℃±5℃, 10s±1s
Rapid change of temperature	0.5: Characteristic [Nil] (Standard) 1: Characteristic [A] (Heat shock resistance)	0.3: Characteristic [Nil] (Standard) 0.5: Characteristic [A] (Heat shock resistance)	Characteristic [Nil] (Standard): −55℃ (30min.)/+125℃ (30min.) 100 cycles Characteristic [A] (Heat shock resistance): −55℃ (30min.)/+125℃ (30min.) 1000 cycles
Moisture resistance	3	0.75	40℃±2℃, 90%~95%RH, 1000h 1.5h ON/0.5h OFF cycle
Endurance at 70℃ or rated terminal part temperature	3	0.75	70℃±2℃ or rated terminal part temperature ±2℃ 1000h 1.5h ON/0.5h OFF cycle
High temperature exposure	1	0.3	+155℃, 1000h

■Precautions for Use

- The substrate of chip resistors is alumina. Cracks may occur at the connection of solder (solder fillet portion) due to the difference of the coefficient of thermal expansion from a mounting board when heat stress like heat cycle, etc. are repeatedly given to them. Care should be taken to the occurrence of the cracks when the change in ambient temperature or ON/OFF of load is repeated. The occurrence of the crack by heat stress may be influenced by the size of a pad, solder volume, heat radiation of mounting board etc., so please pay careful attention to designing when a big change in ambient temperature and conditions for use like ON/OFF of load can be assumed.

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